

MOSFET

OptiMOS[™]5 Power-Transistor, 150 V

Features

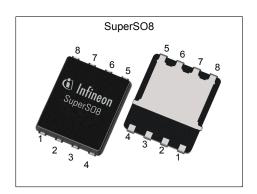
- N-channel, logic level
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

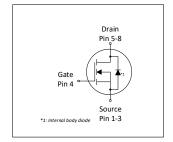
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

- and the state of							
Parameter	Value	Unit					
V _{DS}	150	V					
$R_{ extsf{DS(on),max}}$	10.5	mΩ					
I _D	76	A					
Qoss	81	nC					
Q _G (0V10V)	34	nC					











Type / Ordering Code	Package	Marking	Related Links
BSC105N15LS5	PG-TDSON-8	105N15LS	-

OptiMOS[™]5 Power-Transistor, 150 V BSC105N15LS5



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OptiMOS[™]5 Power-Transistor, 150 V **BSC105N15LS5**



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatan	0		Value	S		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I_{D}	- - -	- - -	76 48 41 10.7	A	V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C V _{GS} =4.5 V, T _C =100 °C V _{GS} =10V, T _A =25 °C, R _{thJA} =50 °C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	304	Α	T _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	62	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	125 2.5	W	T _C =25 °C T _A =25 °C, R _{THJA} =50 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Doromotor	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	-	1.0	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area ²⁾	R _{thJA}	-	-	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

OptiMOS[™]5 Power-Transistor, 150 V BSC105N15LS5



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

D	0		Values	S		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.3	1.8	2.3	V	V _{DS} =V _{GS} , I _D =91 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μΑ	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	8.8 10.9	10.5 14	mΩ	V _{GS} =10 V, I _D =40 A V _{GS} =4.5 V, I _D =20 A
Gate resistance	R _G	-	0.9	1.35	Ω	-
Transconductance	g fs	-	70	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 40 \text{ A}$

Table 5 Dynamic characteristics

Devementar	Cymahal	Values			11	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	2300	3000	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	580	750	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	17	30	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	6.4	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =40 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	2.3	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =40 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	17.8	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =40 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	3.4	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =40 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Danamatan	Oala al	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	7.5	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =40 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	4.1	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =40 A, $V_{\rm GS}$ =0 to 4.5 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	6.9	10.4	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =40 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q_{sw}	-	10.3	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =40 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	18.1	23.0	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =40 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	3.3	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =40 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Q_{g}	-	34	43	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =40 A, $V_{\rm GS}$ =0 to 10 V
Output charge ¹⁾	Qoss	-	81	108	nC	V _{DS} =75 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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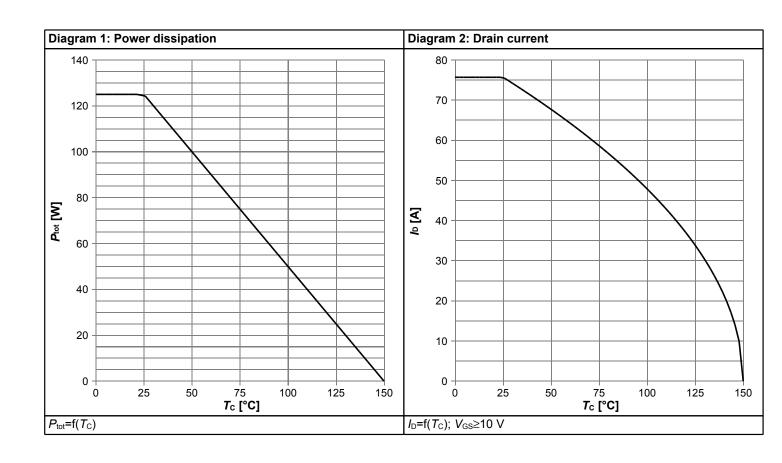


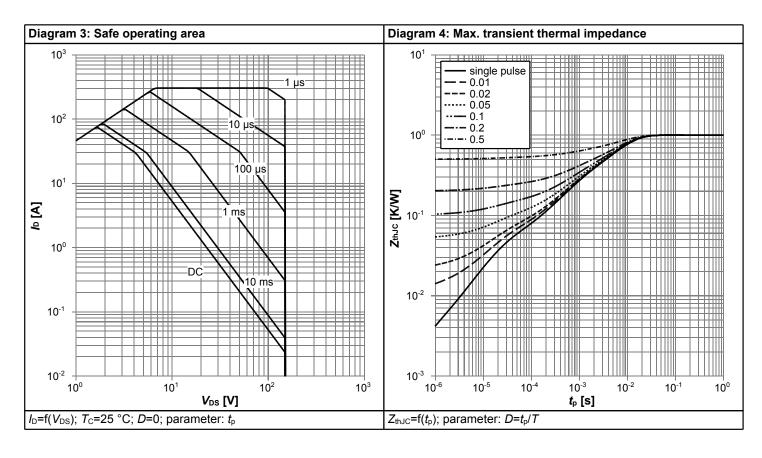
Table 7 Reverse diode

Parameter	Cyronhad	Values			11:4	Nata / Tant Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	76	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	304	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.83	1.2	V	V _{GS} =0 V, I _F =38 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	24.3	48.6	ns	V _R =75 V, I _F =40 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	15.7	31.4	nC	V _R =75 V, I _F =40 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

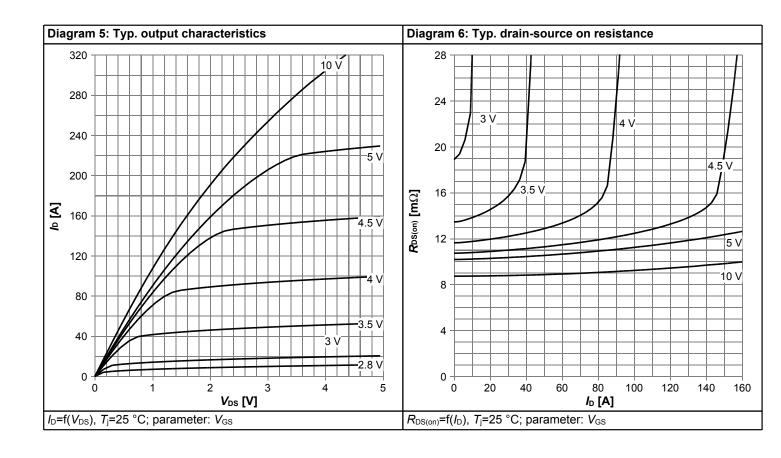


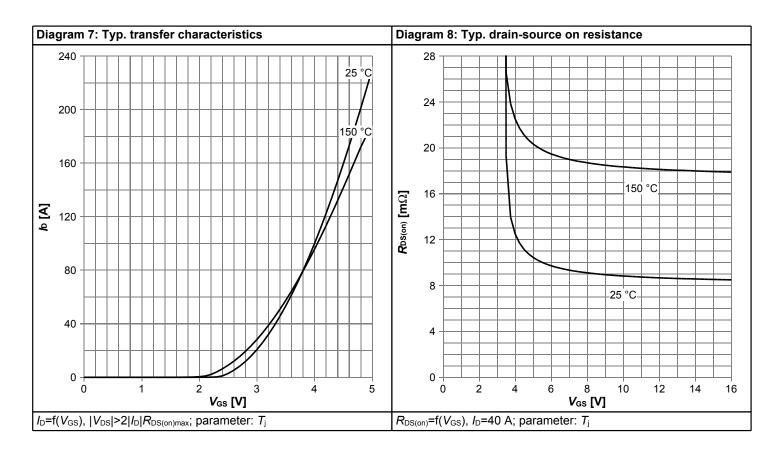
4 Electrical characteristics diagrams



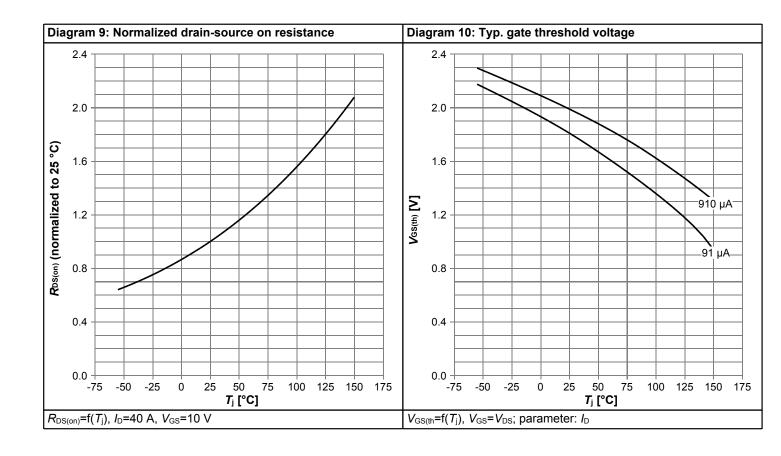


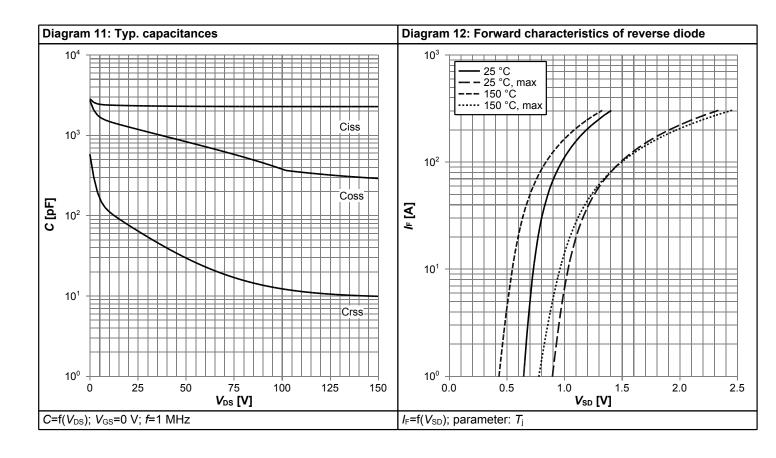




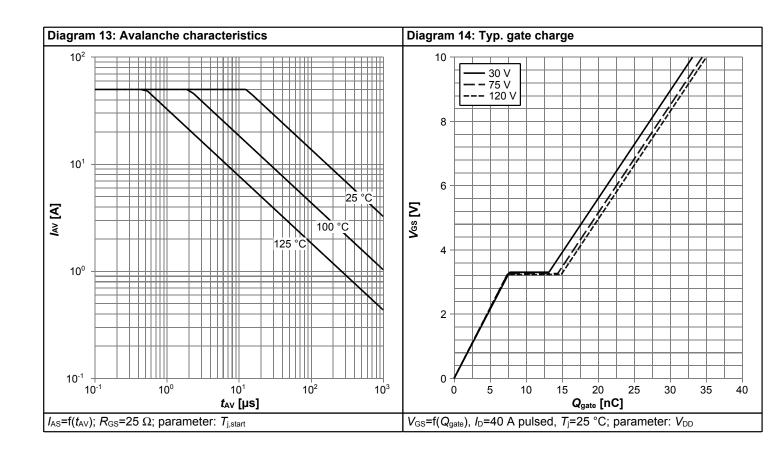


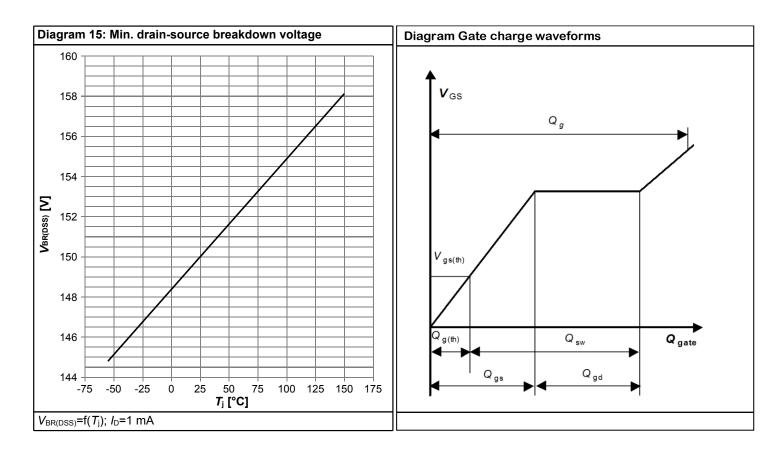






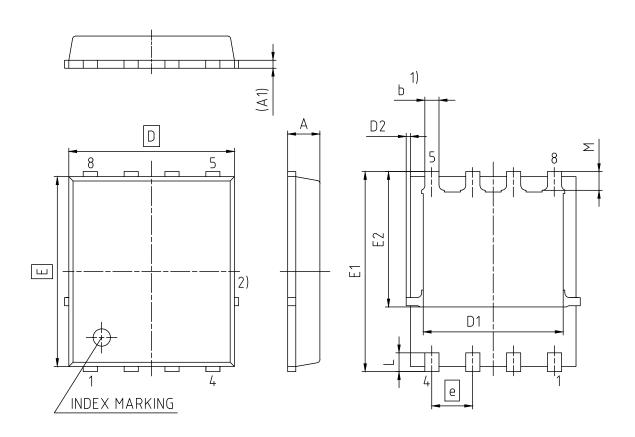








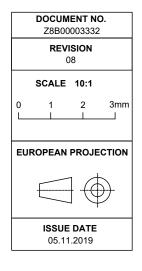
Package Outlines 5



- 1) EXCLUDING MOLD FLASH
- 2) REMOVAL ON MOLD GATE INTRUSION 0.1 MM PROTRUSION 0.1 MM LEAD LENGTH UP TO ANTI FLASH LINE

ALL METAL SURFACES ARE PLATED, EXCEPT AREA OF CUT

DIMENSION	MILLIM	ETERS			
DIMENSION	MIN.	MAX.			
Α	0.90	1.20			
A1	0.15	0.35			
b	0.34	0.54			
D	4.80	5.35			
D1	3.90	4.40			
D2	0.00	0.22			
E	5.70	6.10			
E1	5.90	6.42			
E2	3.88	4.31			
е	1.27				
L	0.45	0.71			
М	0.45	0.69			



Outline PG-TDSON-8, dimensions in mm Figure 1



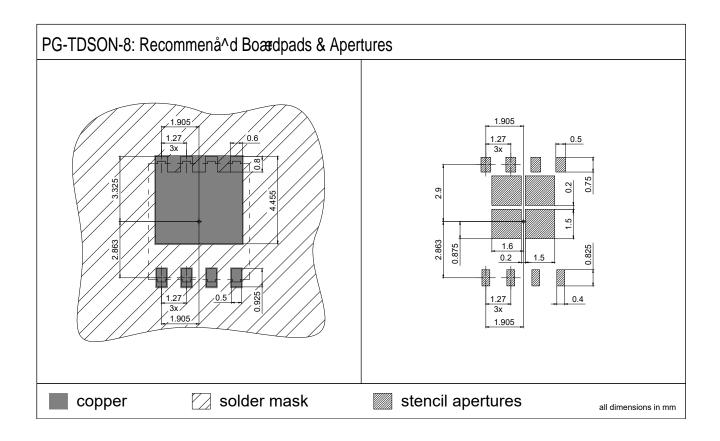


Figure 2 Outline Boardpads (TDSON-8), dimensions in mm

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Revision History

BSC105N15LS5

Revision: 2023-12-13, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2023-12-13	Release of final version

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